

MOS FIELD EFFECT TRANSISTOR 2SK3507

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The 2SK3507 is N-channel MOS FET device that features a low on-state resistance and excellent switching characteristics, designed for low voltage high current applications such as DC/DC converter with synchronous rectifier.

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3507-ZK	TO-252 (MP-3ZK)

FEATURES

- 4.5 V drive available
- · Low on-state resistance

 $R_{DS(on)1} = 45 \text{ m}\Omega \text{ MAX.} \text{ (V}_{GS} = 10 \text{ V}, I_D = 11 \text{ A)}$

· Low gate charge

 $Q_G = 8.5 \text{ nC TYP}$. $(V_{DD} = 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 22 \text{ A})$

- Built-in G-S protection diode
- Surface mount package available

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	VDSS	30	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±16	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	±22	Α
Drain Current (pulse) Note1	D(pulse)	±45	Α
Total Power Dissipation (Tc = 25°C)	P _{T1}	20	W
Total Power Dissipation Note2	P _{T2}	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note3	las	10	Α
Single Avalanche Energy Note3	Eas	10	mJ

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

- 2. Mounted on glass epoxy board of 1 inch x 1 inch x 1.6 mm
- 3. Starting T_{ch} = 25°C, V_{DD} = 15 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V

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ELECTRICAL CHARACTERISTICS (TA = 25°C)

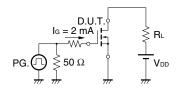
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 30 V, V _{GS} = 0 V			10	μΑ
Gate Leakage Current	Igss	V _{GS} = ±16 V, V _{DS} = 0 V			±10	μΑ
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5		2.5	V
Forward Transfer Admittance Note	y _{fs}	V _{DS} = 4.0 V, I _D = 11 A	6			S
Drain to Source On-state Resistance Note	RDS(on)1	V _{GS} = 10 V, I _D = 11 A		28	45	mΩ
	RDS(on)2	V _{GS} = 4.5 V, I _D = 11 A		46	76	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		360		pF
Output Capacitance	Coss	V _{GS} = 0 V		125		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		65		pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = 15 V, I _D = 11 A		6.6		ns
Rise Time	tr	V _{GS} = 10 V		3.6		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		16		ns
Fall Time	tf			5.3		ns
Total Gate Charge	Q _G	V _{DD} = 24 V		8.5		nC
Gate to Source Charge	Qgs	V _{GS} = 10 V		2		nC
Gate to Drain Charge	Q GD	I _D = 22 A		2.1		nC
Body Diode Forward Voltage Note	V _{F(S-D)}	I _F = 22 A, V _{GS} = 0 V		1.0		V
Reverse Recovery Time	trr	I _F = 22 A, V _{GS} = 0 V		31		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>μ</i> s		26		nC

Note Pulsed

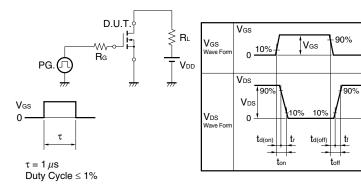
TEST CIRCUIT 1 AVALANCHE CAPABILITY

$V_{GS} = 20 \rightarrow 0 \text{ V}$ V_{DD} V_{DD} V_{DD} V_{DD} V_{DD} V_{DD} V_{DD} V_{DD} V_{DD} V_{DD}

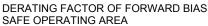
TEST CIRCUIT 3 GATE CHARGE

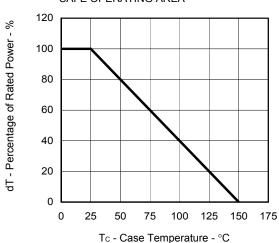


TEST CIRCUIT 2 SWITCHING TIME

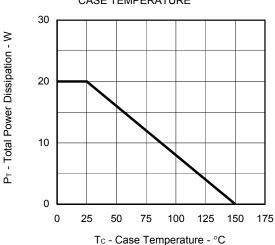


TYPICAL CHARACTERISTICS (TA = 25°C)

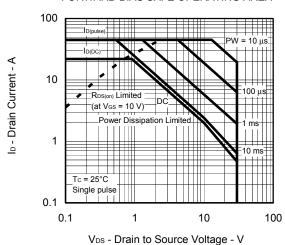




TOTAL POWER DISSIPATION vs. CASE TEMPERATURE

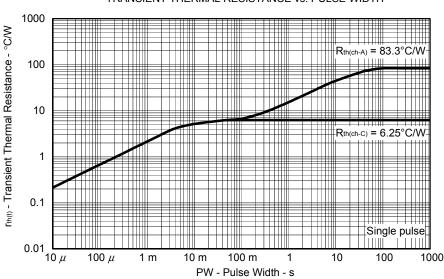


FORWARD BIAS SAFE OPERATING AREA

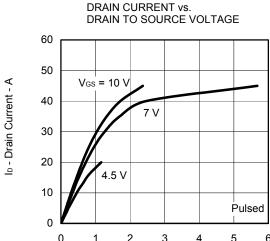


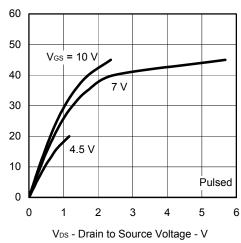
aroc voltage v

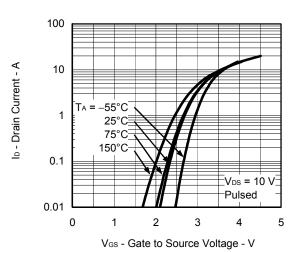
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



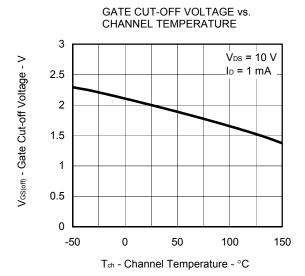
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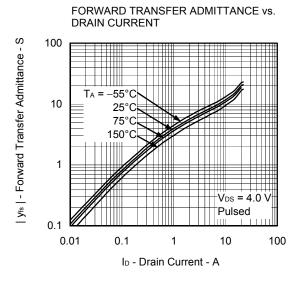


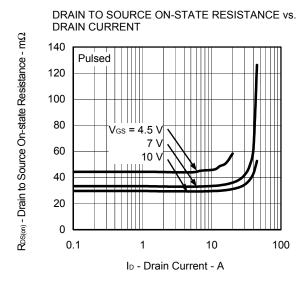


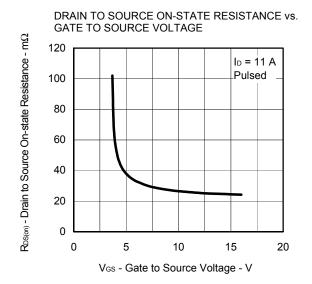


FORWARD TRANSFER CHARACTERISTICS



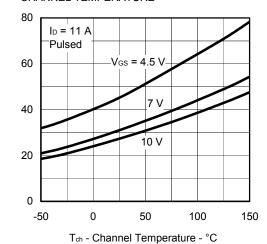




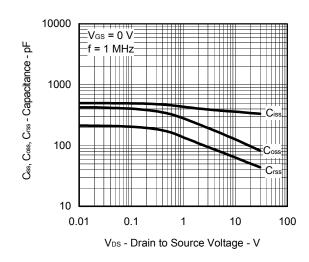


RDS(on) - Drain to Source On-state Resistance - m\Omega

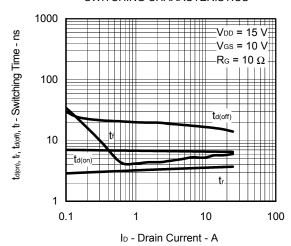
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



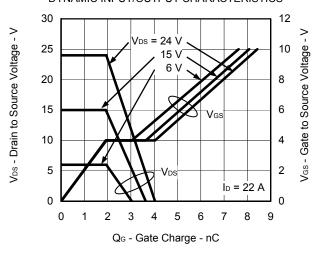
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



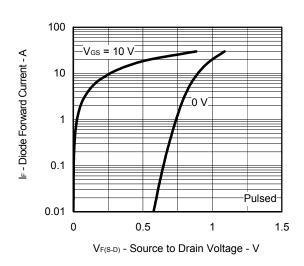
SWITCHING CHARACTERISTICS



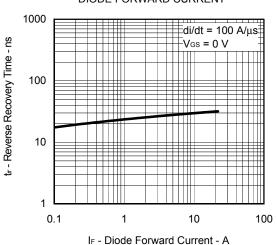
DYNAMIC INPUT/OUTPUT CHARACTERISTICS

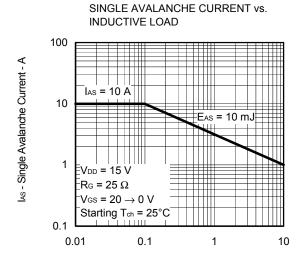


SOURCE TO DRAIN DIODE FORWARD VOLTAGE

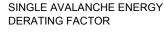


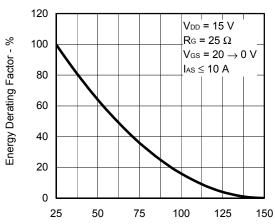
REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT





L - Inductive Load - mH

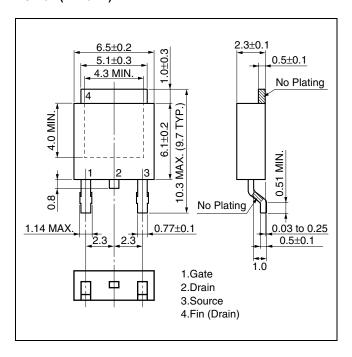




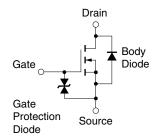
Starting Tch - Starting Channel Temperature - °C

PACKAGE DRAWING (Unit: mm)

TO-252 (MP-3ZK)



EQUIVALENT CIRCUIT



Caution Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD.

When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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